

## **Additional Information**







Resources

Accessories

Samples

## **Description**

Littelfuse WLTC Series low ohm current sense resistor is designed with long term stability in mind. This series is durable, excels at heat dissipation. The small package is optimal for most applications.

#### **Features**

- Low TCR
- Optimal linearity in I / V conversion
- Epoxy substrate

#### **Benefits**

- Small size
- High voltage

## **Application**

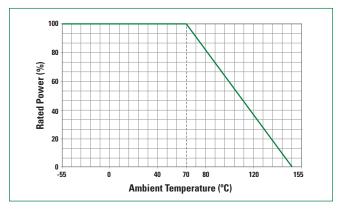
- Power management
- Low ESL

# **Electrical Specifications**

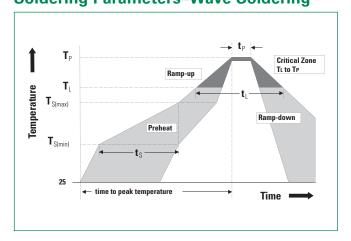
Part Number	Size		<b>Resistance Value</b>		Power Rating	TCR	Standard	
Fait Nulliber	Inch	mm	Ro (mΩ)	Rt (%)	(W)	(ppm / °C)	Package Qty	
WLTC0508RLR002FNR	0508	1220	2	±1.0%	1	±100	5000	
WLTC0508QLR003FNR	0508	1220	3	±1.0%	1	±50	5000	
WLTC0508QLR004FNR	0508	1220	4	±1.0%	1	±50	5000	
WLTC0508QLR005FNR	0508	1220	5	±1.0%	1	±50	5000	
WLTC0612QLR001FNR	0612	1632	1	±1.0%	1	±50	5000	
WLTC0612QLR002FNR	0612	1632	2	±1.0%	1	±50	5000	

Note: Resistors are available in steps of 1mOhm. Ratings not indicated in the above table may be available on request.

## **Temperature De-rating Curve**



# Soldering Parameters–Wave Soldering



# **Storage / Environment Conditions**

Products should be stored under the following environmental conditions.

Temperature:	+5 to +35 °C				
Humidity:	45 to 85% relative humidity				
Moisture Sensitivity Level:	1, J-STD-020				

Do not keep products in environments where they may be subject to particulate contamination or harmful gases such as sulfuric acid or hydrogen chloride as it may cause oxidization on electrodes, resulting poor solderability.

Products should be stored in a space that does not expose to high temperatures, vibration, or direct sunlight.

Products should be stored in the original airtight packaging until use.

Profile Feature	Pb-Free Assembly
Average Ramp-Up Rate (Ts <sub>max</sub> to Tp)	3 °C / second max
<b>Preheat</b> Temperature Minimum (Ts <sub>min</sub> )	150 °C
Temperature Maximum (Ts <sub>max</sub> )	200 °C
Time (Ts <sub>min</sub> to (Ts <sub>max</sub> )	60–180 seconds
$\begin{array}{l} \textbf{Time maintained above} \\ \textbf{Temperature Minimum } (T_L) \\ \textbf{Time } (t_L) \end{array}$	217 ℃ 60–150 seconds
Peak Temperature (T <sub>P</sub> )	260 +0 °C
Time within 5 °C of Actual Peak Temperature (tp)	20-40 seconds
Ramp-Down Rate	6 °C / second Maximum
Time 25 °C to Peak Temperature	8 minutes Maximum

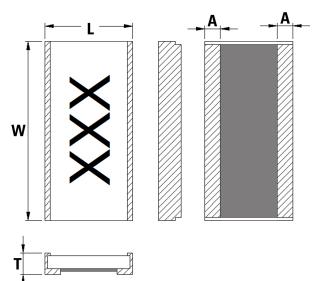
# **Reliability Specifications**

Test	Procedure	Specifications
Resistance Data	Resistance data at 25 °C	Must meet datasheet requirements
TCR Data	TCR data at 25 °C and 125 °C	Must meet datasheet requirements
Dimensional Data	Measure all dimensions specified in datasheet	Must meet datasheet requirements
Short Time Overload IEC60115-1 4.13	Applied voltage: 2.5X rated power. Test period: 5 seconds Test temperature: 25 ± 2 °C	(1.0%+0.5 mΩ)
High Temp. Exposure IEC60115-1 4.25	Test temperature: +155 ± 2 °C Test period: 1,000 hours	±(1.0%+0.5 mΩ)
Low Temp. Storage IEC60115-1 4.25	Test temperature: -55 ± 2 °C Test period: 1,000 hours	±(1.0%+0.5 mΩ)
Moisture Load Life IEC60115-1 4.19	Vtest = Vmax Test temperature: 60 ± 2 °C; RH 95% Test period: 1,000 hours as follows 90 minutes ON, 30 minutes OFF	±(2.0%+0.5 mΩ)
Thermal Shock IEC60115-1 4.19	Test period: 100 cycles as follows -55 °C 30 minutes, room temperature 3 minutes, +155 °C 30 minutes, room temperature 3 minutes	±(1.0%+0.5 mΩ)
Load Life IEC60115-1 4.25	Vtest = Vmax Test temperature: 70 ±2 °C Test period: 1,000 hours as follows 90 minutes ON, 30 minutes OFF	±(2.0%+0.5 mΩ)
Solderability IEC60115-1 4.17	Dipped into solder: Test temperature: 245 ±5 °C Test period: 3 ± 0.5 seconds	The covered area >95%
Resistance to Solder Heat IEC60115-1 4.18	Through reflow, Parts are subjected to 3 reflow cycles	±(1.0%+0.5mΩ)
Mechanical Shock IEC60115-1 4.21	A = 100G Test period: 6 milliseconds	±(1.0%+0.5mΩ)
Substrate Bending IEC60115-1 4.33	Span between fulcrums: 90mm Bend Width: 2mm Test period: 60 seconds Test board: glass-epoxy Thickness: 1.60mm	±(1.0%+0.5mΩ)



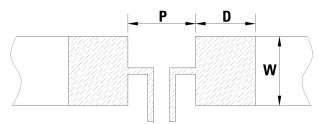
#### **Dimensions**

All dimensions in mm



Part Number	W	L	т	Α
WLTC0508 R001	2.00±0.25	1.25±0.25	0.40±0.15	0.38±0.20
WLTC0508 1M50~R005	2.00±0.25	1.25±0.25	0.40±0.15	0.32±0.20
WLTC0612 R001	3.20±0.25	1.60±0.25	Max 0.45	0.35±0.15
WLTC0612 1M50~R005	3.20±0.25	1.60±0.25	Max 0.40	0.35±0.15

## **Recommended Land Pattern**



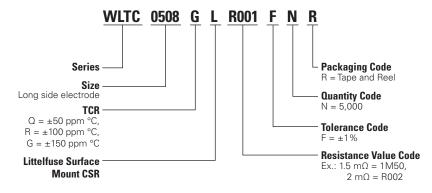
Part Number	Р	W	D	Loading
WLTC0508 R001	0.40 mm	2.30 mm	0.90 mm	1.0 w
WLTC0508 1M50~R005	0.50 mm	2.30 mm	0.85 mm	1.0 w
WLTC0612 R001~R005	0.60 mm	3.68 mm	1.30 mm	1.0 w

# Packaging

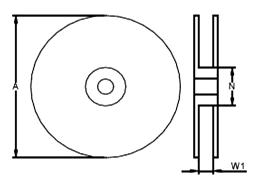
Part Number	Halogen Free	Packaging Option	Quantity	Quantity & Packaging Codes
WLTC0508	Yes	Tape and Reel	5000	NR
WLTC0612	Yes	Tape and Réel	5000	NR



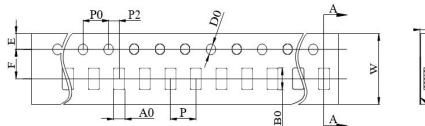
## **Part Numbering System**



#### **Tape and Reel Specifications**



Part Number	A±5 (mm)	N±2 (mm)	W1±1 (mm)
WLTC0508	178	60	9.0
WLTC0612	178	60	9.0



T Resistor Paper Tape Top Tape Bottom Tape

Part Number	W	P0	Р	P2	A0	B0	D0	F	E	т	T1	К0
WLTC0508	8.00±0.30	4.00±0.10	4.00±0.10	2.00±0.10	1.45±0.10	2.20±0.10	1.50±0.10	3.50±0.10	1.75±0.10	0.60±0.10	/	/
WLTC0612	8.00±0.30	4.00±0.10	4.00±0.10	2.00±0.10	1.90±0.20	3.50±0.20	1.50±0.10	3.50±0.10	1.75±0.10	0.60±.010	/	/

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